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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, Serial I/O, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	78
Program Memory Size	128KB (128K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90598gpf-g-185-er

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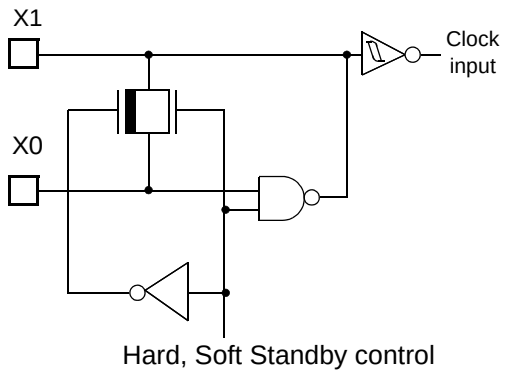
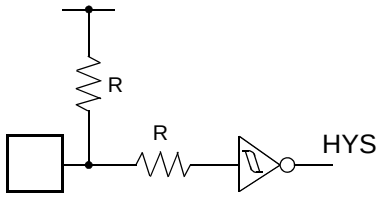
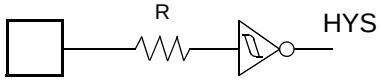
3. Pin Description

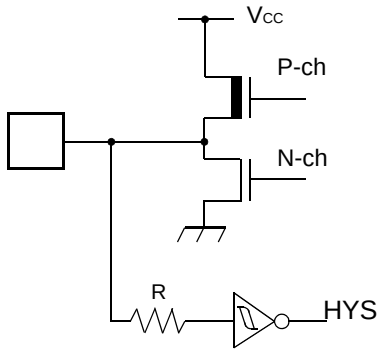
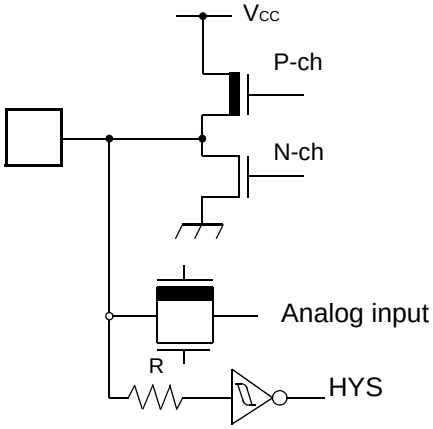
Pin no.	Pin name	Circuit type	Function
82	X0	A	Oscillator pin
83	X1		
77	$\overline{\text{RST}}$	B	Reset input
52	$\overline{\text{HST}}$	C	Hardware standby input
85 to 88	P00 to P03	G	General purpose IO
	IN0 to IN3		Inputs for the Input Captures
89 to 92	P04 to P07	G	General purpose IO
	OUT0 to OUT3		Outputs for the Output Compares.
93 to 98	P10 to P15	D	General purpose IO
	PPG0 to PPG5		Outputs for the Programmable Pulse Generators
99	P16	D	General purpose IO
	TIN1		TIN input for the 16-bit Reload Timer 1
100	P17	D	General purpose IO
	TOT1		TOT output for the 16-bit Reload Timer 1
1 to 8	P20 to P27	G	General purpose IO
9 to 10	P30 to P31	G	General purpose IO
12 to 16	P32 to P36	G	General purpose IO
17	P37	D	General purpose IO
18	P40	G	General purpose IO
	SOT0		SOT output for UART 0
19	P41	G	General purpose IO
	SCK0		SCK input/output for UART 0
20	P42	G	General purpose IO
	SIN0		SIN input for UART 0
21	P43	G	General purpose IO
	SIN1		SIN input for UART 1
22	P44	G	General purpose IO
	SCK1		SCK input/output for UART 1
24	P45	G	General purpose IO
	SOT1		SOT output for UART 1
25	P46	G	General purpose IO
	SOT2		SOT output for the Serial IO
26	P47	G	General purpose IO
	SCK2		SCK input/output for the Serial IO

Pin no.	Pin name	Circuit type	Function
28	P50	D	General purpose IO
	SIN2		SIN Input for the Serial IO
29 to 32	P51 to P54	D	General purpose IO
	INT4 to INT7		External interrupt input for INT4 to INT7
33	P55	D	General purpose IO
	ADTG		Input for the external trigger of the A/D Converter
38 to 41	P60 to P63	E	General purpose IO
	AN0 to AN3		Inputs for the A/D Converter
43 to 46	P64 to P67	E	General purpose IO
	AN4 to AN7		Inputs for the A/D Converter
47	P56	D	General purpose IO
	TIN0		TIN input for the 16-bit Reload Timer 0
48	P57	D	General purpose IO
	TOT0		TOT output for the 16-bit Reload Timer 0
54 to 57	P70 to P73	F	General purpose IO
	PWM1P0 PWM1M0 PWM2P0 PWM2M0		Output for Stepper Motor Controller channel 0
59 to 62	P74 to P77	F	General purpose IO
	PWM1P1 PWM1M1 PWM2P1 PWM2M1		Output for Stepper Motor Controller channel 1
64 to 67	P80 to P83	F	General purpose IO
	PWM1P2 PWM1M2 PWM2P2 PWM2M2		Output for Stepper Motor Controller channel 2
69 to 72	P84 to P87	F	General purpose IO
	PWM1P3 PWM1M3 PWM2P3 PWM2M3		Output for Stepper Motor Controller channel 3
74	P90	D	General purpose IO
	TX		TX output for CAN Interface
75	P91	D	General purpose IO
	RX		RX input for CAN Interface

Pin no.	Pin name	Circuit type	Function
76	P92	D	General purpose IO
	INT0		External interrupt input for INT0
78 to 80	P93 to P95	D	General purpose IO
	INT1 to INT3		External interrupt input for INT1 to INT3
58, 68	DV_{CC}	—	Dedicated power supply pins for the high current output buffers (Pin No. 54 to 72)
53, 63, 73	DV_{SS}	—	Dedicated ground pins for the high current output buffers (Pin No. 54 to 72)
34	AV_{CC}	Power supply	Dedicated power supply pin for the A/D Converter
37	AV_{SS}	Power supply	Dedicated ground pin for the A/D Converter
35	AVRH	Power supply	Upper reference voltage input for the A/D Converter
36	AVRL	Power supply	Lower reference voltage input for the A/D Converter
49, 50	MD0 MD1	C	Operating mode selection input pins. These pins should be connected to V_{CC} or V_{SS}.
51	MD2	H	Operating mode selection input pin. This pin should be connected to V_{CC} or V_{SS}.
27	C	—	External capacitor pin. A capacitor of 0.1μF should be connected to this pin and V_{SS}.
23, 84	V_{CC}	Power supply	Power supply pins (5.0 V).
11, 42, 81	V_{SS}	Power supply	Ground pins (0.0 V).

4. I/O Circuit Type

Circuit Type	Circuit	Remarks
A		■ Oscillation feedback resistor: 1 MΩ approx.
B		■ Hysteresis input with pull-up Resistor: 50 kΩ approx.
C		■ Hysteresis input

Circuit Type	Circuit	Remarks
D		■ CMOS output ■ CMOS Hysteresis input
E		■ CMOS output ■ CMOS Hysteresis input ■ Analog input

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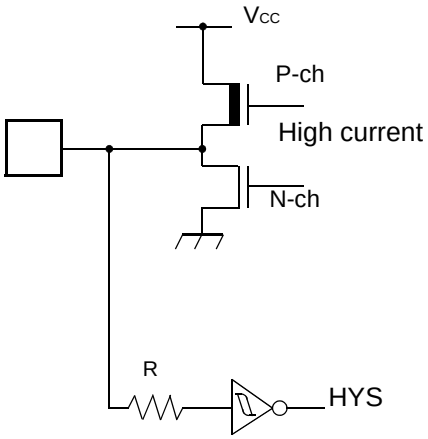
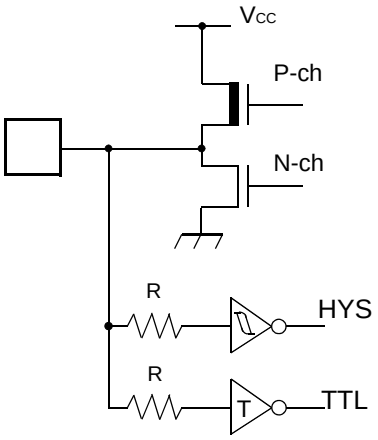
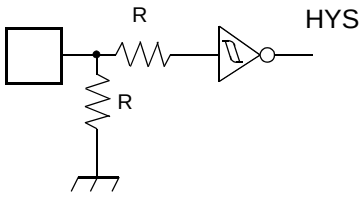
Circuit Type	Circuit	Remarks
F		■ CMOS high current output ■ CMOS Hysteresis input
G		■ CMOS output ■ CMOS Hysteresis input ■ TTL input (MB90F598G, only in Flash mode)
H		■ Hysteresis input Pull-down Resistor: 50 kΩ approx. (except MB90F598G)

5. Handling Devices

(1) Make Sure that the Voltage not Exceed the Maximum Rating (to Avoid a Latch-up).

In CMOS ICs, a latch-up phenomenon is caused when an voltage exceeding V_{CC} or an voltage below V_{SS} is applied to input or output pins or a voltage exceeding the rating is applied across V_{CC} and V_{SS}.

When a latch-up is caused, the power supply current may be dramatically increased causing resultant thermal break-down of devices. To avoid the latch-up, make sure that the voltage not exceed the maximum rating.

In turning on/turning off the analog power supply, make sure the analog power voltage (AV_{CC}, AVRH, DV_{CC}) and analog input voltages not exceed the digital voltage (V_{CC}).

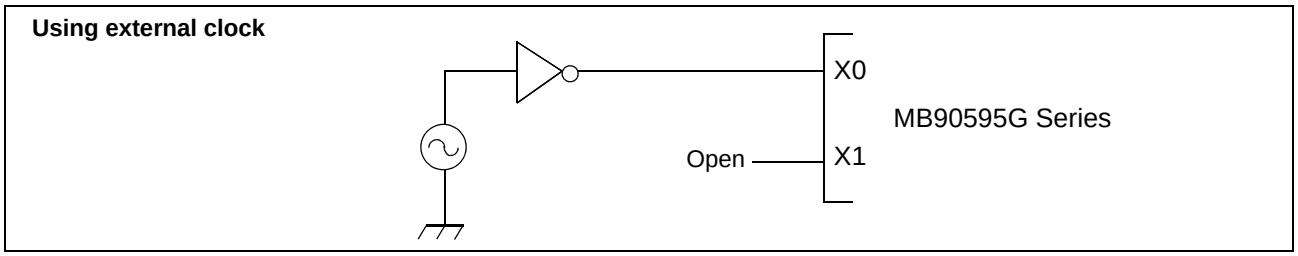
(2) Treatment of Unused Pins

Unused input pins left open may cause abnormal operation, or latch-up leading to permanent damage. Unused input pins should be pulled up or pulled down through at least 2 kΩ resistance.

Unused input/output pins may be left open in output state, but if such pins are in input state they should be handled in the same way as input pins.

(3) Using external clock

In using the external clock, drive X0 pin only and leave X1 pin unconnected.

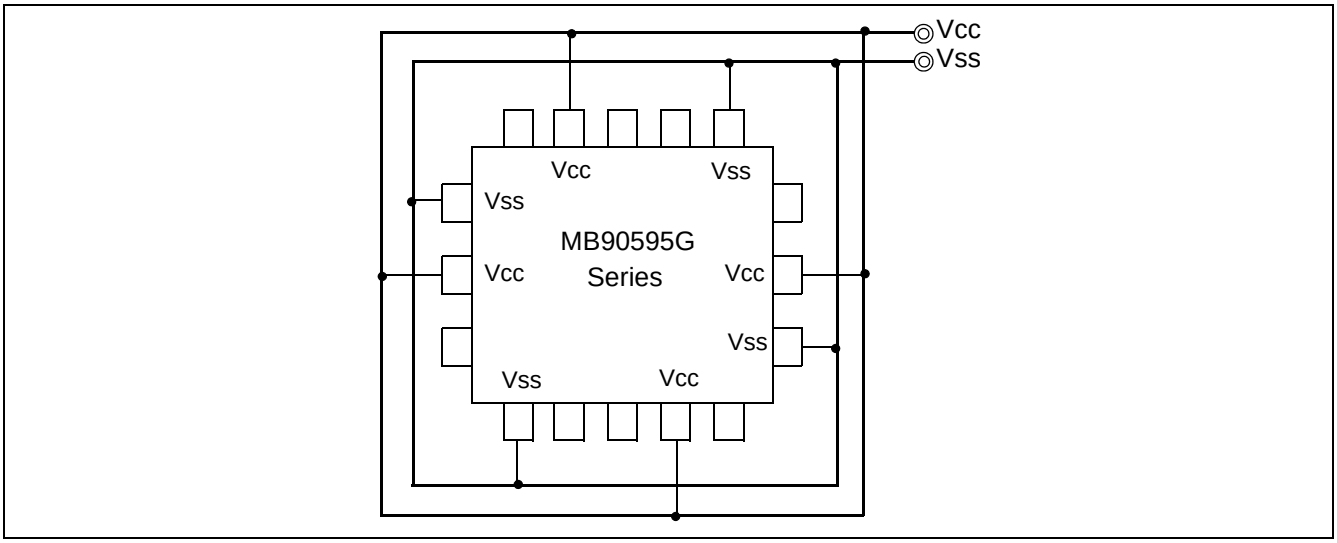


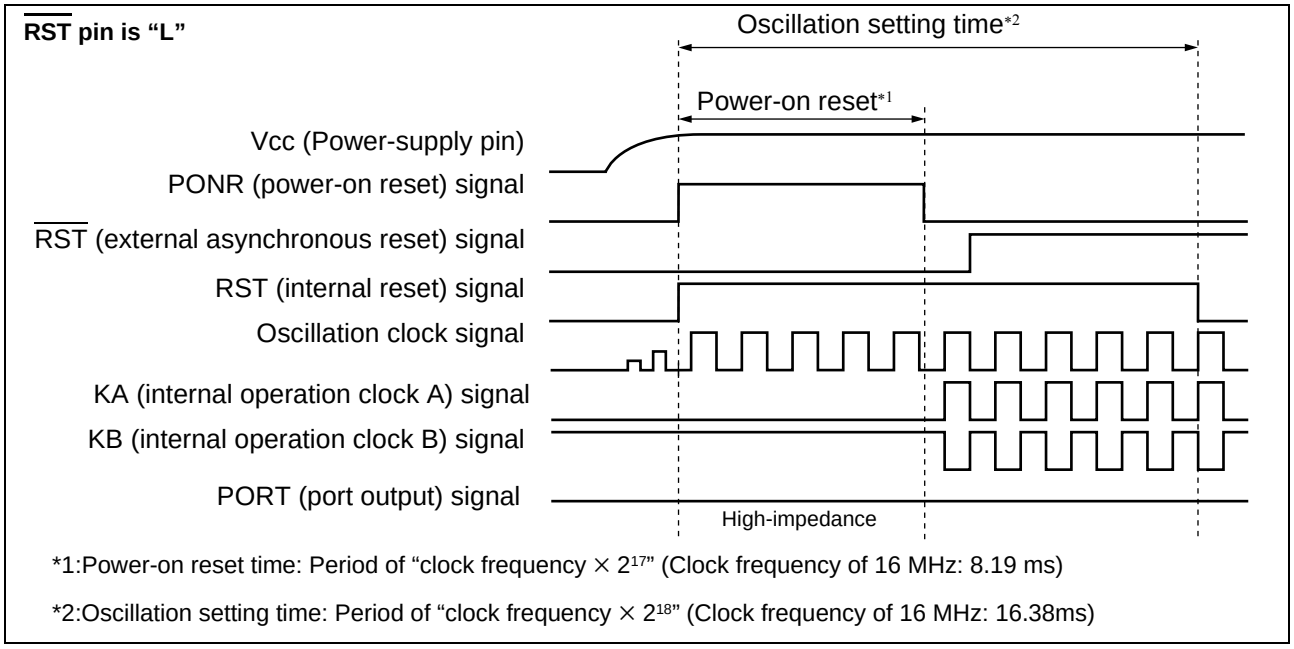
(4) Power supply pins (Vcc/Vss)

In products with multiple V_{cc} or V_{ss} pins, pins with the same potential are internally connected in the device to avoid abnormal operations including latch-up. However, you must connect the pins to an external power and a ground line to lower the electro-magnetic emission level, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total current rating (See the figure below.)

Make sure to connect V_{cc} and V_{ss} pins via lowest impedance to power lines.

It is recommended to provide a bypass capacitor of around 0.1 μF between V_{cc} and V_{ss} pins near the device.





*1:Power-on reset time: Period of “clock frequency × 2^{17}” (Clock frequency of 16 MHz: 8.19 ms)

*2:Oscillation setting time: Period of “clock frequency × 2^{18}” (Clock frequency of 16 MHz: 16.38ms)

(12) Initialization

The device contains internal registers which are initialized only by a power-on reset. To initialize these registers, please turn on the power again.

(13) Directions of “DIV A, Ri” and “DIVW A, RWi” instructions

In the signed multiplication and division instructions (“DIV A, Ri” and “DIVW A, RWi”), the value of the corresponding bank register (DTB, ADB, USB, SSB) is set in “00_H”.

If the values of the corresponding bank register (DTB,ADB,USB,SSB) are set to other than “00_H”, the remainder by the execution result of the instruction is not stored in the register of the instruction operand.

(14) Using REALOS

The use of EI^2OS is not possible with the REALOS real time operating system.

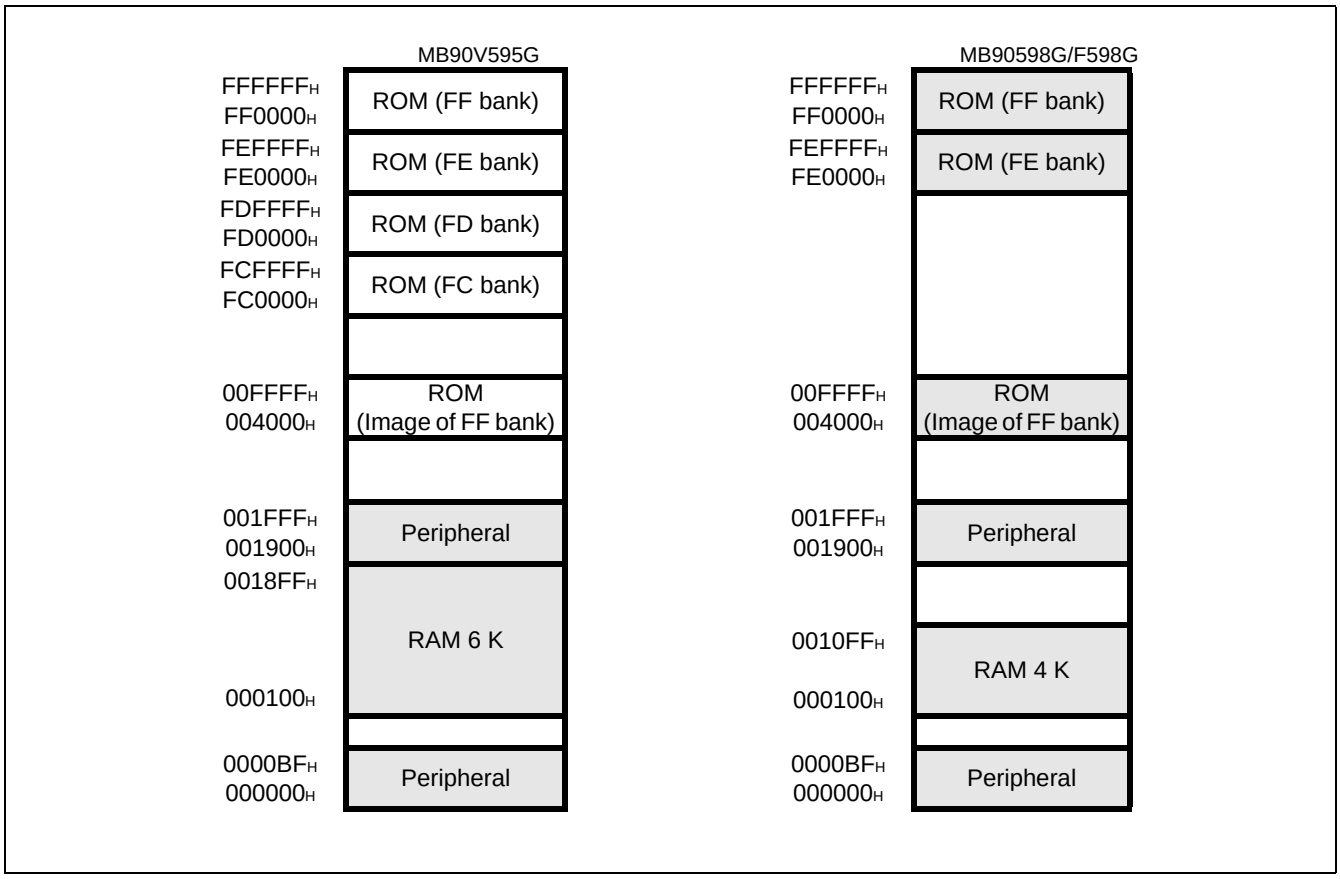
(15) Caution on Operations during PLL Clock Mode

If the PLL clock mode is selected in the microcontroller, it may attempt to continue the operation using the free-running frequency of the automatic oscillating circuit in the PLL circuitry even if the oscillator is out of place or the clock input is stopped. Performance of this operation, however, cannot be guaranteed.

7. Memory Space

The memory space of the MB90595G Series is shown below

Figure 1. Memory space map



Note: : The ROM data of bank FF is reflected in the upper address of bank 00, realizing effective use of the C compiler small model. The lower 16-bit of bank FF and the lower 16-bit of bank 00 are assigned to the same address, enabling reference of the table on the ROM without stating “far”.
For example, if an attempt has been made to access 00C000H , the contents of the ROM at FFC000H are accessed. Since the ROM area of the FF bank exceeds 48 Kbytes, the whole area cannot be reflected in the image for the 00 bank. The ROM data at FF4000H to FFFFFFH looks, therefore, as if it were the image for 004000H to 00FFFFH. Thus, it is recommended that the ROM data table be stored in the area of FF4000H to FFFFFFH.

Address	Register	Abbreviation	Access	Peripheral	Initial value
6F$_H$	ROM Mirror Function Selection Register	ROMM	R/W	ROM Mirror	_ _ _ _ _ _ _ 1$_B$
70$_H$	PWM1 Compare Register 0	PWC10	R/W	Stepping Motor Controller 0	XXXXXXXX$_B$
71$_H$	PWM2 Compare Register 0	PWC20	R/W		XXXXXXXX$_B$
72$_H$	PWM1 Select Register 0	PWS10	R/W		_ _ 0 0 0 0 0 0$_B$
73$_H$	PWM2 Select Register 0	PWS20	R/W		_ 0 0 0 0 0 0 0$_B$
74$_H$	PWM1 Compare Register 1	PWC11	R/W	Stepping Motor Controller 1	XXXXXXXX$_B$
75$_H$	PWM2 Compare Register 1	PWC21	R/W		XXXXXXXX$_B$
76$_H$	PWM1 Select Register 1	PWS11	R/W		_ _ 0 0 0 0 0 0$_B$
77$_H$	PWM2 Select Register 1	PWS21	R/W		_ 0 0 0 0 0 0 0$_B$
78$_H$	PWM1 Compare Register 2	PWC12	R/W	Stepping Motor Controller 2	XXXXXXXX$_B$
79$_H$	PWM2 Compare Register 2	PWC22	R/W		XXXXXXXX$_B$
7A$_H$	PWM1 Select Register 2	PWS12	R/W		_ _ 0 0 0 0 0 0$_B$
7B$_H$	PWM2 Select Register 2	PWS22	R/W		_ 0 0 0 0 0 0 0$_B$
7C$_H$	PWM1 Compare Register 3	PWC13	R/W	Stepping Motor Controller 3	XXXXXXXX$_B$
7D$_H$	PWM2 Compare Register 3	PWC23	R/W		XXXXXXXX$_B$
7E$_H$	PWM1 Select Register 3	PWS13	R/W		_ _ 0 0 0 0 0 0$_B$
7F$_H$	PWM2 Select Register 3	PWS23	R/W		_ 0 0 0 0 0 0 0$_B$
80$_H$ to 8F$_H$	CAN Controller. Refer to section about CAN Controller				
90$_H$ to 9D$_H$	Reserved				
9E$_H$	Program Address Detection Control Status Register	PACSR	R/W	Address Match Detection Function	0 0 0 0 0 0 0 0$_B$
9F$_H$	Delayed Interrupt/Request Register	DIRR	R/W	Delayed Interrupt	_ _ _ _ _ _ _ 0$_B$
A0$_H$	Low-Power Mode Control Register	LPMCR	R/W	Low Power Controller	0 0 0 1 1 0 0 0$_B$
A1$_H$	Clock Selection Register	CKSCR	R/W	Low Power Controller	1 1 1 1 1 1 0 0$_B$
A2$_H$ to A7$_H$	Reserved				
A8$_H$	Watchdog Timer Control Register	WDTC	R/W	Watchdog Timer	XXXXX 1 1 1$_B$
A9$_H$	Time Base Timer Control Register	TBTC	R/W	Time Base Timer	1 _ _ 0 0 1 0 0$_B$
AA$_H$ to AD$_H$	Reserved				
AE$_H$	Flash Memory Control Status Register (MB90F598G only. Otherwise reserved)	FMCS	R/W	Flash Memory	0 0 0 X 0 0 0 0$_B$
AF$_H$	Reserved				

(Continued)

(Continued)

Address	Register	Abbreviation	Access	Peripheral	Initial value
192C$_H$	Output Compare Register 2 (low-order)	OCCP2	R/W	Output Compare 2/3	XXXXXXXX$_B$
192D$_H$	Output Compare Register 2 (high-order)	OCCP2	R/W		XXXXXXXX$_B$
192E$_H$	Output Compare Register 3 (low-order)	OCCP3	R/W		XXXXXXXX$_B$
192F$_H$	Output Compare Register 3 (high-order)	OCCP3	R/W		XXXXXXXX$_B$
1930$_H$ to 19FF$_H$	Reserved				
1A00$_H$ to 1AFF$_H$	CAN Controller. Refer to section about CAN Controller				
1B00$_H$ to 1BFF$_H$	CAN Controller. Refer to section about CAN Controller				
1C00$_H$ to 1EFF$_H$	Reserved				
1FF0$_H$	Program Address Detection Register 0 (low-order)	PADR0	R/W	Address Match Detection Function	XXXXXXXX$_B$
1FF1$_H$	Program Address Detection Register 0 (middle-order)				XXXXXXXX$_B$
1FF2$_H$	Program Address Detection Register 0 (high-order)				XXXXXXXX$_B$
1FF3$_H$	Program Address Detection Register 1 (low-order)	PADR1	R/W		XXXXXXXX$_B$
1FF4$_H$	Program Address Detection Register 1 (middle-order)				XXXXXXXX$_B$
1FF5$_H$	Program Address Detection Register 1 (high-order)				XXXXXXXX$_B$
1FF6$_H$ to 1FFF$_H$	Reserved				

■ Description for Read/Write
R/W : Readable/writable
R : Read only
W : Write only

■ Description of initial value
0 : the initial value of this bit is "0".
1 : the initial value of this bit is "1".
X : the initial value of this bit is undefined.
_ : this bit is unused. the initial value is undefined.

Note: : Addresses in the range of 0000$_H$ to 00FF$_H$, which are not listed in the table, are reserved for the primary functions of the MCU. A read access to these reserved addresses results in reading “X”, and any write access should not be performed.

(Continued)

Address	Register	Abbreviation	Access	Initial Value
001B08H	IDE register	IDER	R/W	XXXXXXXX XXXXXXXXB
001B09H				
001B0AH	Transmit RTR register	TRTRR	R/W	00000000 00000000B
001B0BH				
001B0CH	Remote frame receive waiting register	RFWTR	R/W	XXXXXXXX XXXXXXXXB
001B0DH				
001B0EH	Transmit interrupt enable register	TIER	R/W	00000000 00000000B
001B0FH				
001B10H	Acceptance mask select register	AMSR	R/W	XXXXXXXX XXXXXXXXB
001B11H				
001B12H				XXXXXXXX XXXXXXXXB
001B13H				
001B14H	Acceptance mask register 0	AMR0	R/W	XXXXXXXX XXXXXXXXB
001B15H				
001B16H				XXXXX--- XXXXXXXXB
001B17H				
001B18H	Acceptance mask register 1	AMR1	R/W	XXXXXXXX XXXXXXXXB
001B19H				
001B1AH				XXXXX--- XXXXXXXXB
001B1BH				

9.2 List of Message Buffers (ID Registers)

Address	Register	Abbreviation	Access	Initial Value
001A00H to 001A1FH	General-purpose RAM	--	R/W	XXXXXXXXB to XXXXXXXXB
001A20H	ID register 0	IDR0	R/W	XXXXXXXX XXXXXXXXB
001A21H				
001A22H				XXXXX--- XXXXXXXXB
001A23H				
001A24H	ID register 1	IDR1	R/W	XXXXXXXX XXXXXXXXB
001A25H				
001A26H				XXXXX--- XXXXXXXXB
001A27H				
001A28H	ID register 2	IDR2	R/W	XXXXXXXX XXXXXXXXB
001A29H				
001A2AH				XXXXX--- XXXXXXXXB
001A2BH				

Address	Register	Abbreviation	Access	Initial Value
001A2C$_H$	ID register 3	IDR3	R/W	XXXXXXXX XXXXXXXX$_B$
001A2D$_H$				
001A2E$_H$				XXXXX--- XXXXXXXX$_B$
001A2F$_H$				
001A30$_H$	ID register 4	IDR4	R/W	XXXXXXXX XXXXXXXX$_B$
001A31$_H$				
001A32$_H$				XXXXX--- XXXXXXXX$_B$
001A33$_H$				
001A34$_H$	ID register 5	IDR5	R/W	XXXXXXXX XXXXXXXX$_B$
001A35$_H$				
001A36$_H$				XXXXX--- XXXXXXXX$_B$
001A37$_H$				
001A38$_H$	ID register 6	IDR6	R/W	XXXXXXXX XXXXXXXX$_B$
001A39$_H$				
001A3A$_H$				XXXXX--- XXXXXXXX$_B$
001A3B$_H$				
001A3C$_H$	ID register 7	IDR7	R/W	XXXXXXXX XXXXXXXX$_B$
001A3D$_H$				
001A3E$_H$				XXXXX--- XXXXXXXX$_B$
001A3F$_H$				

(Continued)

11.2 Recommended Conditions

(V_{SS} = AV_{SS} = 0.0 V)

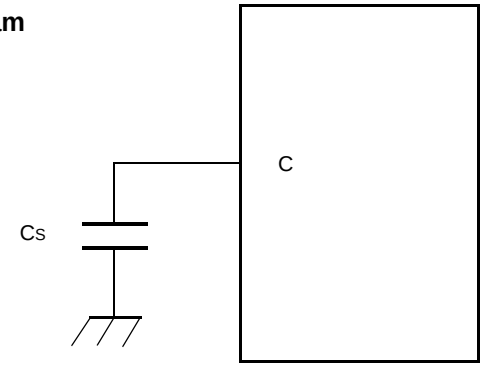
Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC} AV_{CC}	4.5	5.0	5.5	V	Under normal operation
		3.0	—	5.5	V	Maintains RAM data in stop mode
Smooth capacitor	C_S	0.022	0.1	1.0	µF	*
Operating temperature	T_A	–40	—	+85	°C	

*: Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The smoothing capacitor to be connected to the V_{CC} pin must have a capacitance value higher than C_S.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

- **C Pin Connection Diagram**



11.3 DC Characteristics

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input H voltage	V_{IHS}	CMOS hysteresis input pin	—	0.8 V_{CC}	—	V_{CC} +0.3	V	
	V_{IHM}	MD input pin	—	V_{CC} – 0.3	—	V_{CC} +0.3	V	
Input L voltage	V_{ILS}	CMOS hysteresis input pin	—	V_{SS} – 0.3	—	0.2 V_{CC}	V	
	V_{ILM}	MD input pin	—	V_{SS} – 0.3	—	V_{SS} +0.3	V	
Output H voltage	V_{OH1}	Output pins except P70 to P87	V_{CC} = 4.5 V, I_{OH1} = –4.0 mA	V_{CC} – 0.5	—	—	V	
	V_{OH2}	P70 to P87	V_{CC} = 4.5 V, I_{OH2} = –30.0 mA	V_{CC} – 0.5	—	—	V	
Output L voltage	V_{OL1}	Output pins except P70 to P87	V_{CC} = 4.5 V, I_{OL1} = 4.0 mA	—	—	0.4	V	
	V_{OL2}	P70 to P87	V_{CC} = 4.5 V, I_{OL2} = 30.0 mA	—	—	0.5	V	

11.4.2 Reset and Hardware Standby Input

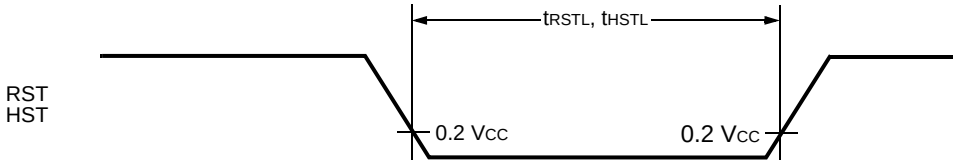
(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Value		Unit	Remarks
			Min	Max		
Reset input time	t_{RSTL}	$\overline{RST}$	16 t_{CP}*1	—	ns	Under normal operation
			Oscillation time of oscillator*2 + 16 t_{CP}*1	—	ms	In stop mode
Hardware standby input time	t_{HSTL}	$\overline{HST}$	16 t_{CP}*1	—	ns	Under normal operation
			Oscillation time of oscillator*2 + 16 t_{CP}*1	—	ms	In stop mode

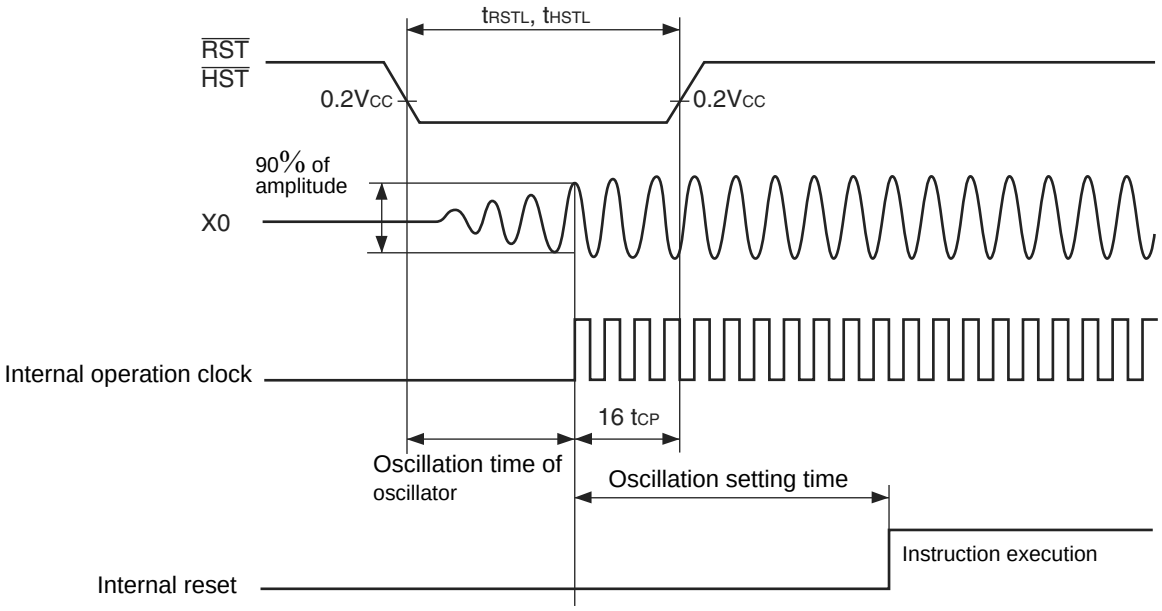
*1: "t_{cp}" represents one cycle time of the machine clock.
No reset can fully initialize the Flash Memory if it is performing the automatic algorithm.

*2: Oscillation time of oscillator is time that the amplitude reached the 90%.
In the crystal oscillator, the oscillation time is between several ms to tens of ms. In ceramic oscillator, the oscillation time is between hundreds of μs to several ms. In the external clock, the oscillation time is 0 ms.

Under Normal Operation



In Stop Mode



11.4.3 Power On Reset

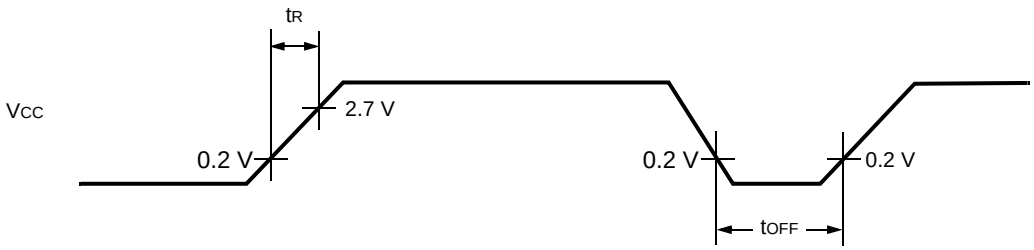
(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Power on rise time	t_R	V_{CC}	—	0.05	30	ms	*
Power off time	t_{OFF}	V_{CC}		50	—	ms	Due to repetitive operation

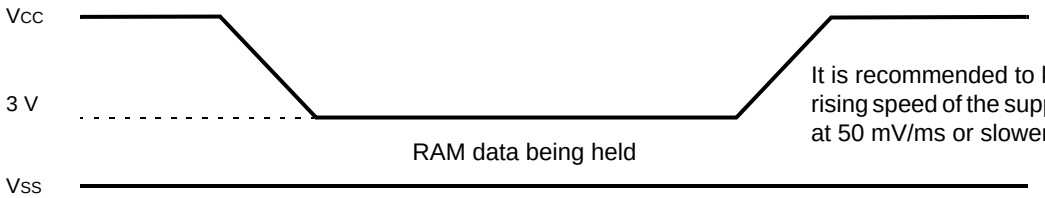
*: V_{CC} must be kept lower than 0.2 V before power-on.

Notes:

- The above values are used for creating a power-on reset.
- Some registers in the device are initialized only upon a power-on reset. To initialize these registers, turn on the power supply using the above values.



Sudden changes in the power supply voltage may cause a power-on reset.
To change the power supply voltage while the device is in operation, it is recommended to raise the voltage smoothly to suppress fluctuations as shown below.
In this case, change the supply voltage with the PLL clock not used. If the voltage drop is 1 V or less per second, however, you can use the PLL clock.



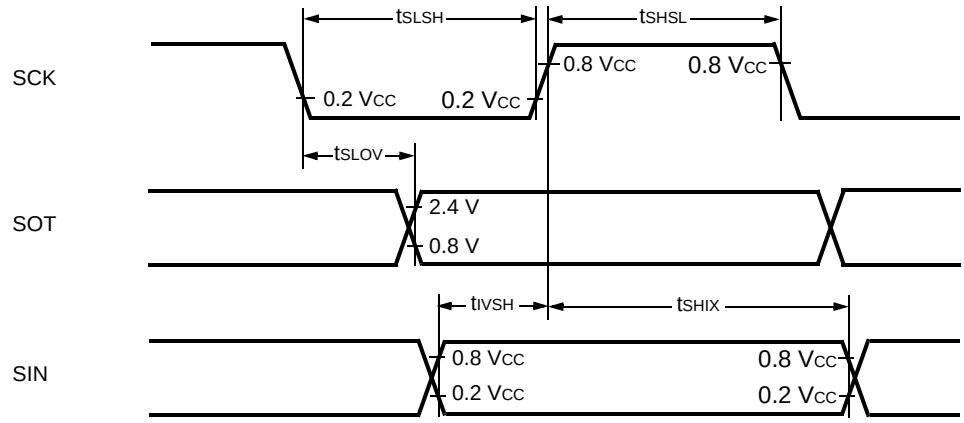
It is recommended to keep the rising speed of the supply voltage at 50 mV/ms or slower.

11.4.4 UART0/1, Serial I/O Timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK0 to SCK2	Internal clock operation output pins are C_L = 80 pF + 1 TTL.	8 t_{CP}	—	ns	
SCK ↓ ⇒ SOT delay time	t_{SLOV}	SCK0 to SCK2, SOT0 to SOT2		–80	80	ns	
Valid SIN ⇒ SCK ↑	t_{IVSH}	SCK0 to SCK2, SIN0 to SIN2		100	—	ns	
SCK ↑ ⇒ Valid SIN hold time	t_{SHIX}	SCK0 to SCK2, SIN0 to SIN2		60	—	ns	

• **External Shift Clock Mode**

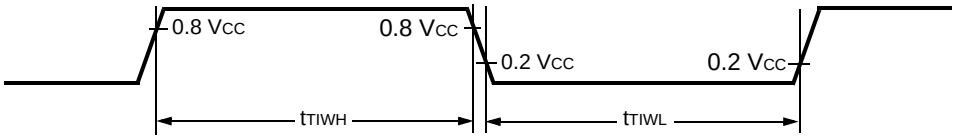


(5) Timer Input Timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TIWH}	TIN0, TIN1	—	4 t_{CP}	—	ns	
	t_{TIWL}	IN0 to IN3					

• **Timer Input Timing**

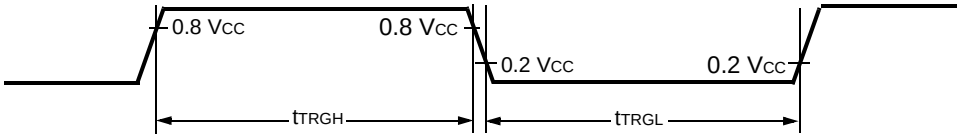


11.4.5 Trigger Input Timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TRGH}	INT0 to INT7, ADTG	—	5 t_{CP}	—	ns	Under normal operation
	t_{TRGL}			1	—	µs	In stop mode

- **Trigger Input Timing**



11.4.6 Slew Rate High Current Outputs (MB90598G, MB90F598G only)

(V_{CC} = 5.0 V±10 %, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Output Rise/Fall time	t_{R2} t_{F2}	Port P70 to P77, Port P80 to P87	—	15	40	150	ns	

- Slew Rate Output Timing

$V_H = V_{OL2} + 0.1 \times (V_{OH2} - V_{OL2})$
$V_L = V_{OL2} + 0.9 \times (V_{OH2} - V_{OL2})$

11.5 A/D Converter

(V_{CC} = AV_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V,3.0 V ≤ AVRH − AVRL, T_A = −40 °C to +85 °C)

Parameter	Sym-bol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—		10	bit	
Conversion error	—	—	—	—	±5.0	LSB	
Nonlinearity error	—	—	—	—	±2.5	LSB	
Differential linearity error	—	—	—	—	±1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN7	AVRL − 3.5 LSB	AVRL + 0.5 LSB	AVRL + 4.5 LSB	V	
Full scale transition voltage	V_{FST}	AN0 to AN7	AVRH − 6.5 LSB	AVRH − 1.5 LSB	AVRH + 1.5 LSB	V	
Conversion time	—	—	—	352t_{CP}	—	ns	
Sampling time	—	—	—	64t_{CP}	—	ns	
Analog port input current	I_{AIN}	AN0 to AN7	−10	—	10	µA	
Analog input voltage range	V_{AIN}	AN0 to AN7	AVRL	—	AVRH	V	

11.8 Flash memory

■ Erase and programming performance

Parameter	Condition	Value			Unit	Remarks	
		Min	Typ	Max			
Sector erase time	$T_A = +25\ ^{\circ}C$, $V_{CC} = 5.0$ V	—	1	15	s	MB90F598G	Excludes 00H programming prior erasure
Chip erase time		—	5	—	s	MB90F598G	Excludes 00H programming prior
Word (16-bit) programming time		—	16	3600	µs	MB90F598G	Excludes system-level overhead
Erase/Program cycle	—	10000	—	—	cycle		

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